



Artificial Intelligence in Electrical Engineering: Emerging Research and Perspectives

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Message from the Guest Editors

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The field of electrical engineering is experiencing rapid advancements driven by innovations in technology, materials, and methodologies.

The aim is to bring together cutting-edge research that spans a wide range of topics, including but not limited to renewable energy, signal processing, telecommunications, control systems, and electromagnetics. This collection of articles showcases groundbreaking work from leading researchers and provides insights into emerging trends and future directions in electrical engineering. The selected papers will not only present novel theoretical contributions but also emphasize practical applications and experimental validations. By focusing on both current challenges and upcoming opportunities, this Special Issue intends to serve as a valuable resource for researchers, engineers, and practitioners.

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Message from the Editor-in-Chief

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